

Model Name: EBA42.5001-10

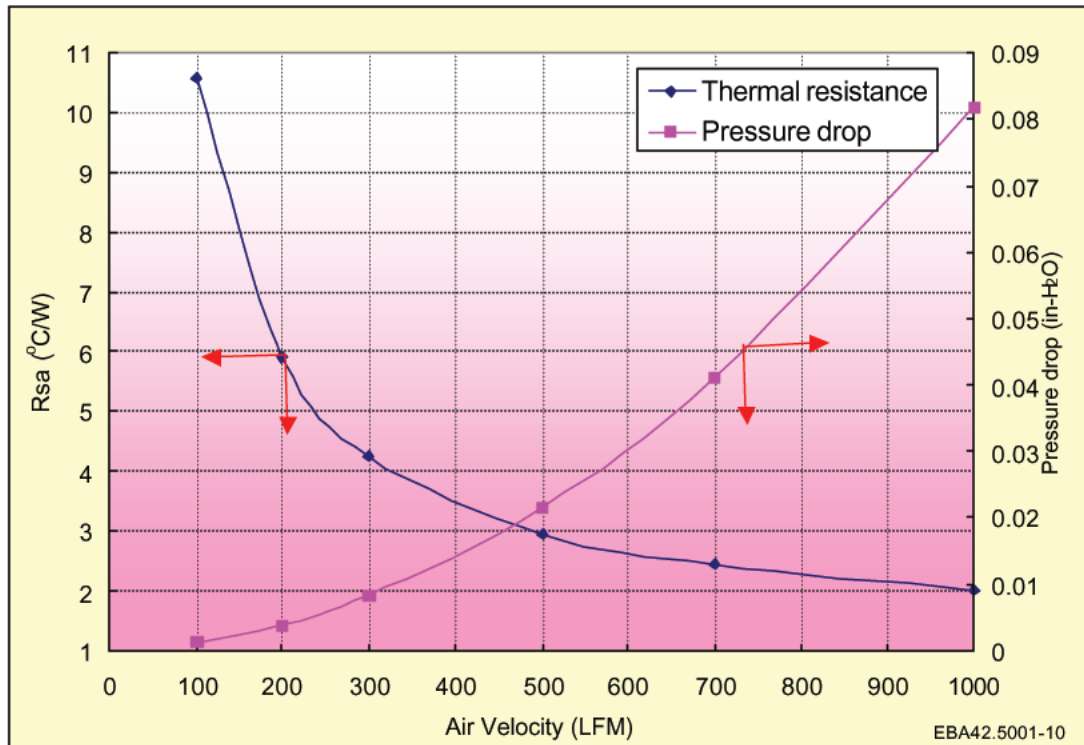
BGA Heat Sink For 42.5x42.5 Chip set

*Specification:

1. **Material:** Aluminum 6063
2. **Weight:** 21 gm
3. **Technology:** Extrusion
4. **Finish:** Black Anodize
5. **Heat Sink Dimension:**
41.5*41.5*10.05mm
6. **Copper package and Moulding compound package available**
7. **Heat Source size:** Uniform



*Performance Data:



AMERICAN THERMAL PRODUCTS

Medland & Associates, Inc.

Tel: 408-686-0460

Fax: 408-686-0462

Email: sales@medlandandassociates.com

www.medlandandassociates.com